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# ES1DR

200 V, 1 A hyperfast PN-rectifier

28 March 2018

Product data sheet

## 1. General description

High power density, hyperfast PN-rectifier with high-efficiency planar technology, encapsulated in a small and flat lead SOD123W Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Reverse voltage  $V_R \leq 200$  V
- Forward current  $I_F \leq 1$  A
- Switching time  $t_{rr} \leq 25$  ns
- Pt doped life time control
- Low inductance
- Small and flat lead SMD plastic package
- Package height typ. 1 mm
- High power capability due to clip-bond technology
- Planar die design
- Capable for reflow and wave soldering

## 3. Applications

- General-purpose rectification
- Reverse polarity protection
- Hyperfast switching
- Freewheeling applications

## 4. Quick reference data


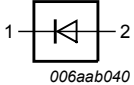
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 140$ °C		-	-	1	A
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25$ °C		-	-	200	V
$V_R$	reverse voltage			-	-	200	V
$V_F$	forward voltage	$I_F = 1$ A; pulsed; $T_j = 25$ °C	[1]	-	845	930	mV
		$I_F = 1$ A; pulsed; $T_j = 125$ °C	[1]	-	700	790	mV
$I_R$	reverse current	$V_R = 200$ V; pulsed; $T_j = 25$ °C	[1]	-	5	200	nA
		$V_R = 200$ V; pulsed; $T_j = 125$ °C	[1]	-	1.5	20	µA

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 CFP3 (SOD123W)	 006aab040
2	A	anode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
ES1DR	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

## 7. Marking

Table 4. Marking codes

Type number	Marking code
ES1DR	KM

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	200	V
$V_R$	reverse voltage			-	200	V
$V_{RMS}$	RMS voltage			-	140	V
$I_F$	forward current	$\delta = 1; T_{sp} \leq 137\text{ °C}$		-	1.4	A
$I_{F(AV)}$	average forward current	$\delta = 0.5; f = 20\text{ kHz};$ square wave; $T_{sp} \leq 140\text{ °C}$		-	1	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8.3\text{ ms}; T_{j(\text{init})} = 25\text{ °C};$ single half sine wave (applied at rated load condition)		-	32	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	735	mW
			[2]	-	1.19	W
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	170	K/W
			[2]	-	-	105	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

[3] Soldering point of cathode tab.

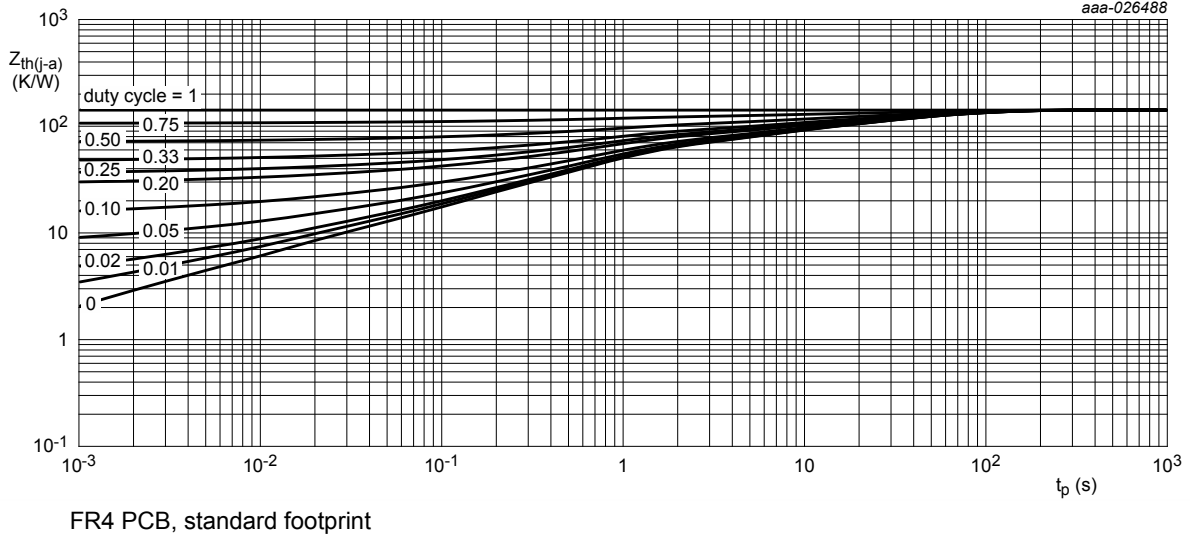


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

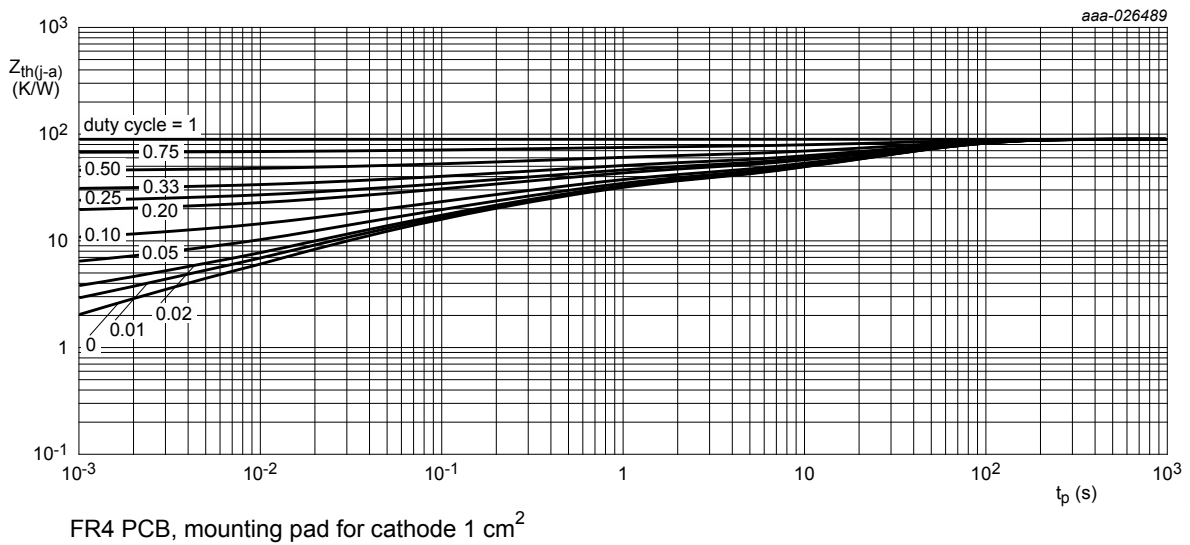


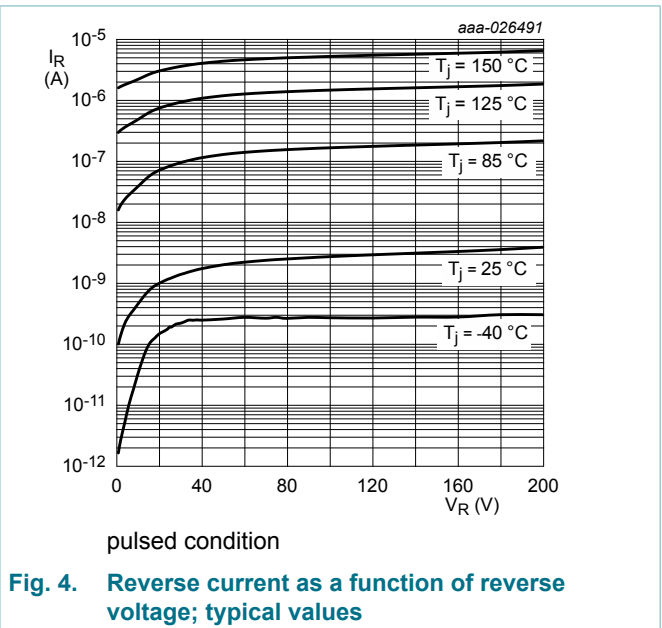
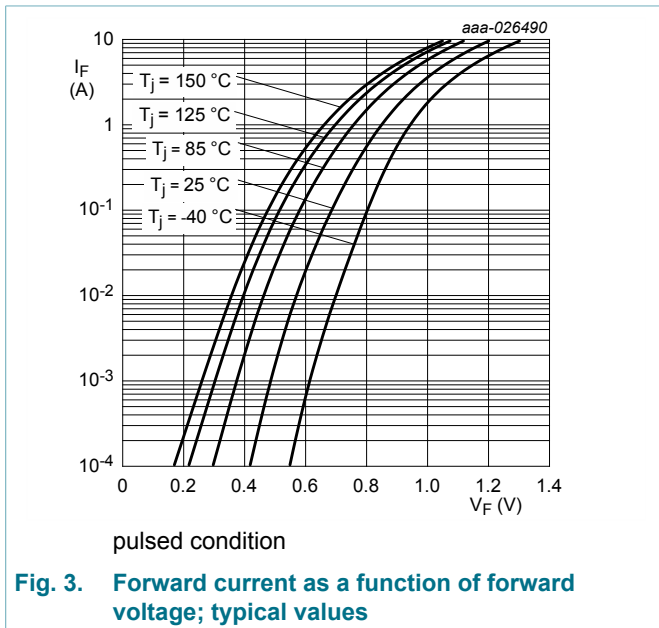
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

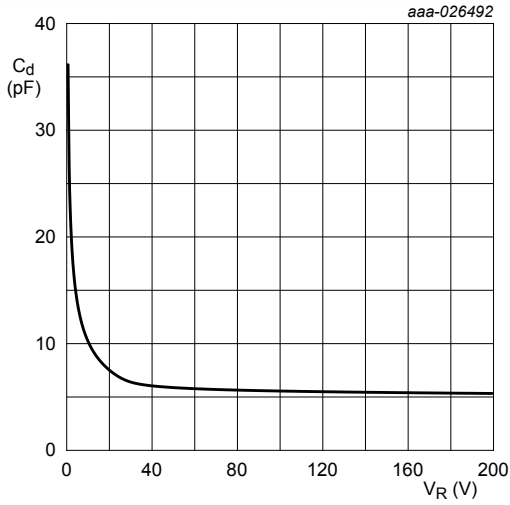
## 10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 100 \mu\text{A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	200	-	-	V
$V_F$	forward voltage	$I_F = 1 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	-	845	930	mV
		$I_F = 1 \text{ A}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$	[1]	-	700	790	mV
$I_R$	reverse current	$V_R = 200 \text{ V}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	-	5	200	nA
		$V_R = 200 \text{ V}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$	[1]	-	1.5	20	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 4 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	17	-	pF
$t_{rr}$	reverse recovery time ; step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(\text{meas})} = 0.25 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	10	25	ns
	reverse recovery time ; ramp recovery	$I_F = 1 \text{ A}$ ; $dI_F/dt = 50 \text{ A}/\mu\text{s}$ ; $V_R = 30 \text{ V}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	20	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 1 \text{ A}$ ; $dI_F/dt = 50 \text{ A}/\mu\text{s}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	930	-	mV

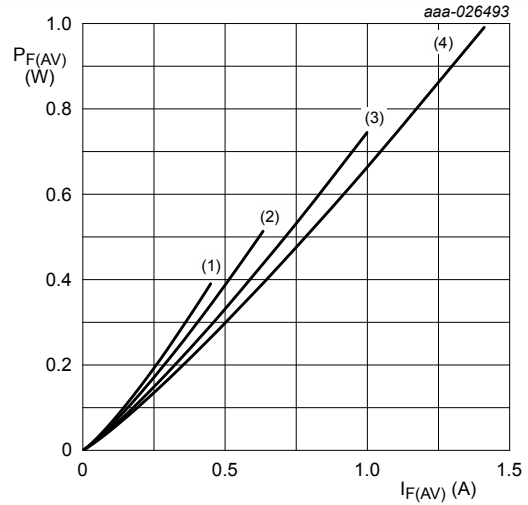
[1] Very short pulse, in order to maintain a stable junction temperature.





$f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

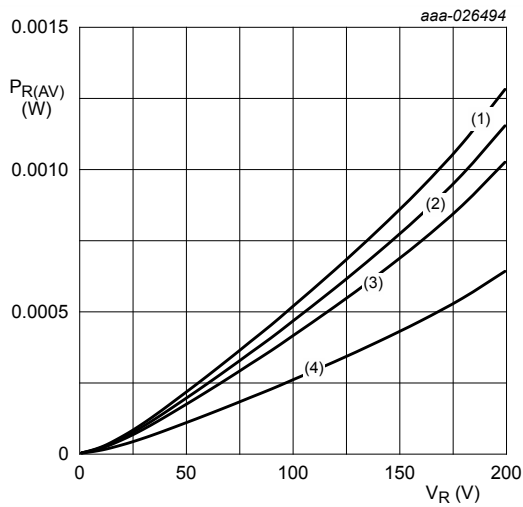
**Fig. 5. Diode capacitance as a function of reverse voltage; typical values**



$T_j = 150 \text{ }^\circ\text{C}$

- (1)  $\delta = 0.1$
- (2)  $\delta = 0.2$
- (3)  $\delta = 0.5$
- (4)  $\delta = 1 \text{ (DC)}$

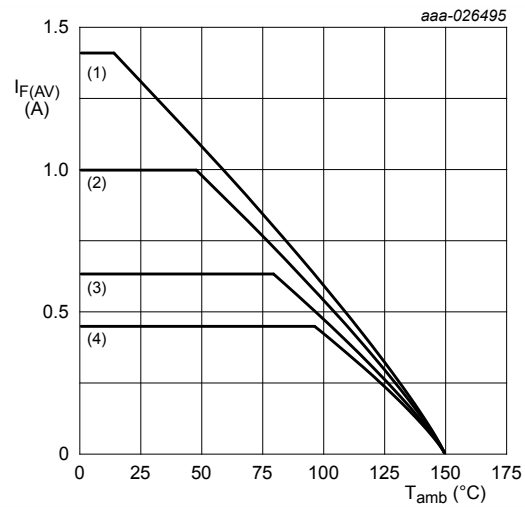
**Fig. 6. Average forward power dissipation as a function of average forward current; typical values**



$T_j = 150 \text{ }^\circ\text{C}$

- (1)  $\delta = 1; \text{DC}$
- (2)  $\delta = 0.9$
- (3)  $\delta = 0.8$
- (4)  $\delta = 0.5$

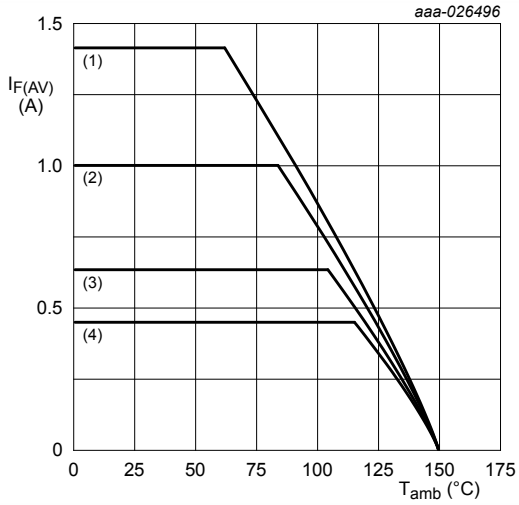
**Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values**



FR4 PCB, standard footprint

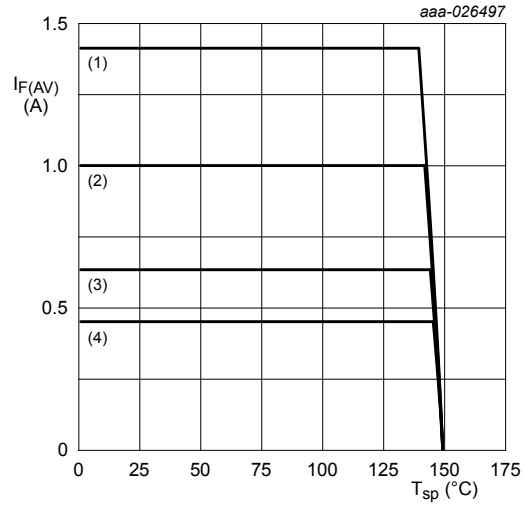
- $T_j = 150 \text{ }^\circ\text{C}$
- (1)  $\delta = 1; \text{DC}$
- (2)  $\delta = 0.5; f = 20 \text{ kHz}$
- (3)  $\delta = 0.2; f = 20 \text{ kHz}$
- (4)  $\delta = 0.1; f = 20 \text{ kHz}$

**Fig. 8. Average forward current as a function of ambient temperature; typical values**



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  
 $T_j = 150$  °C  
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20$  kHz  
 (3)  $\delta = 0.2$ ;  $f = 20$  kHz  
 (4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



$T_j = 150$  °C  
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 20$  kHz  
 (3)  $\delta = 0.2$ ;  $f = 20$  kHz  
 (4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

## 11. Test information

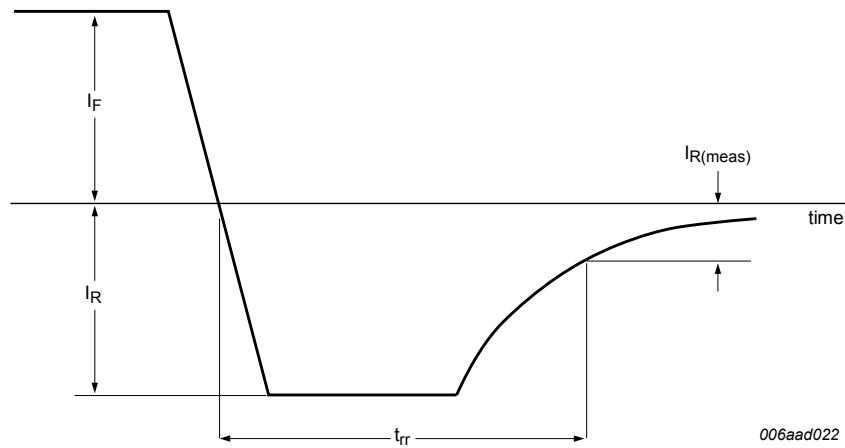


Fig. 11. Reverse recovery definition; step recovery



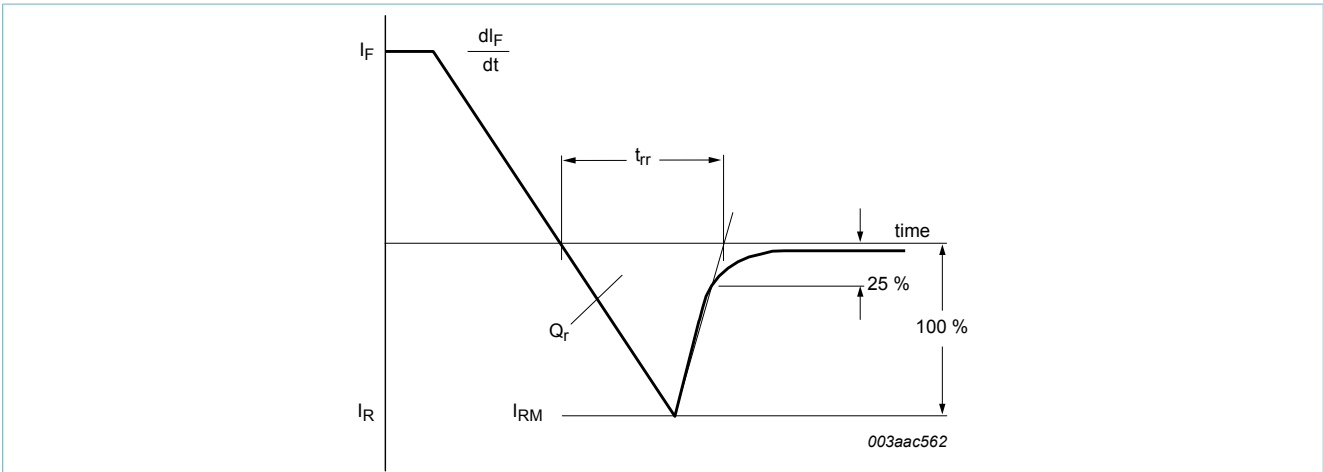


Fig. 12. Reverse recovery definition; ramp recovery

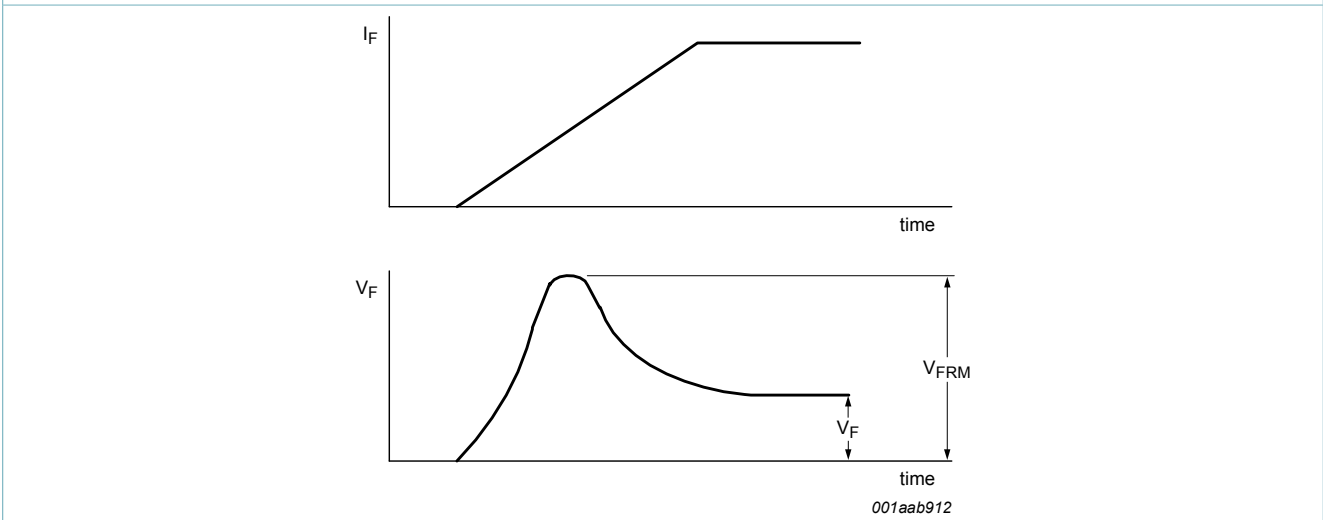


Fig. 13. Forward recovery definition

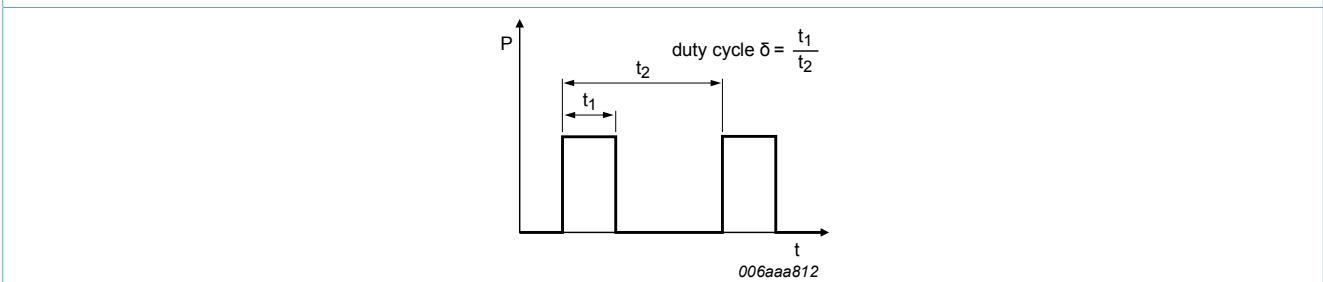


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

## 12. Package outline

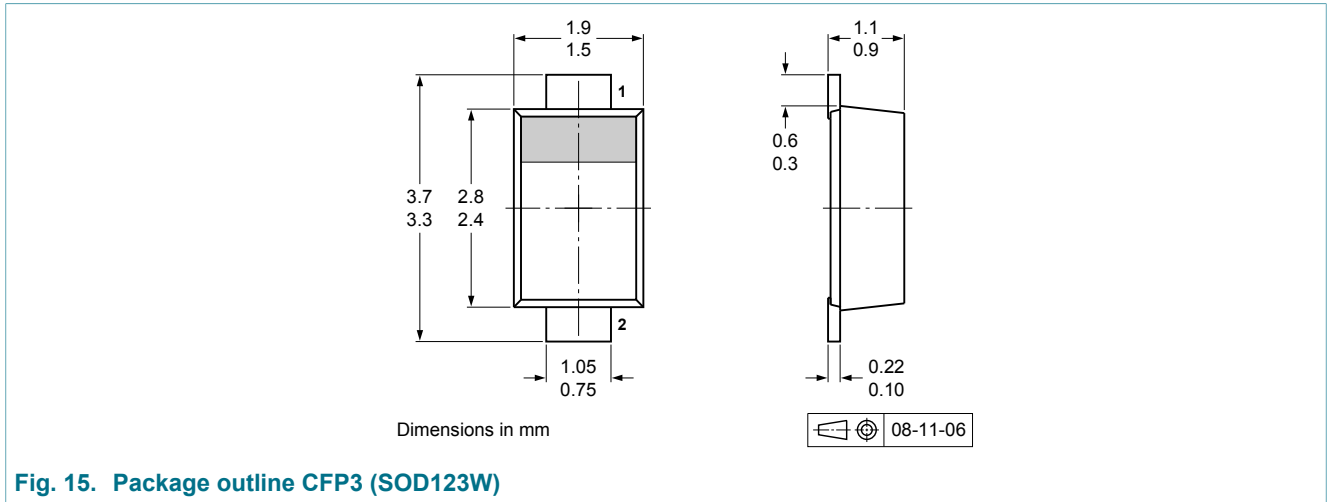


Fig. 15. Package outline CFP3 (SOD123W)

## 13. Soldering

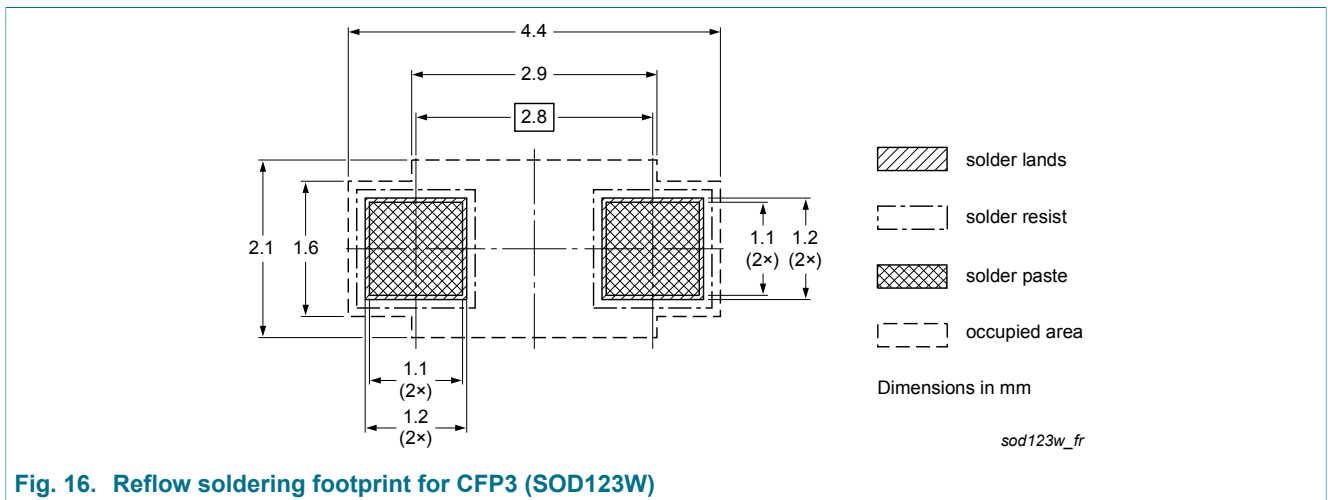
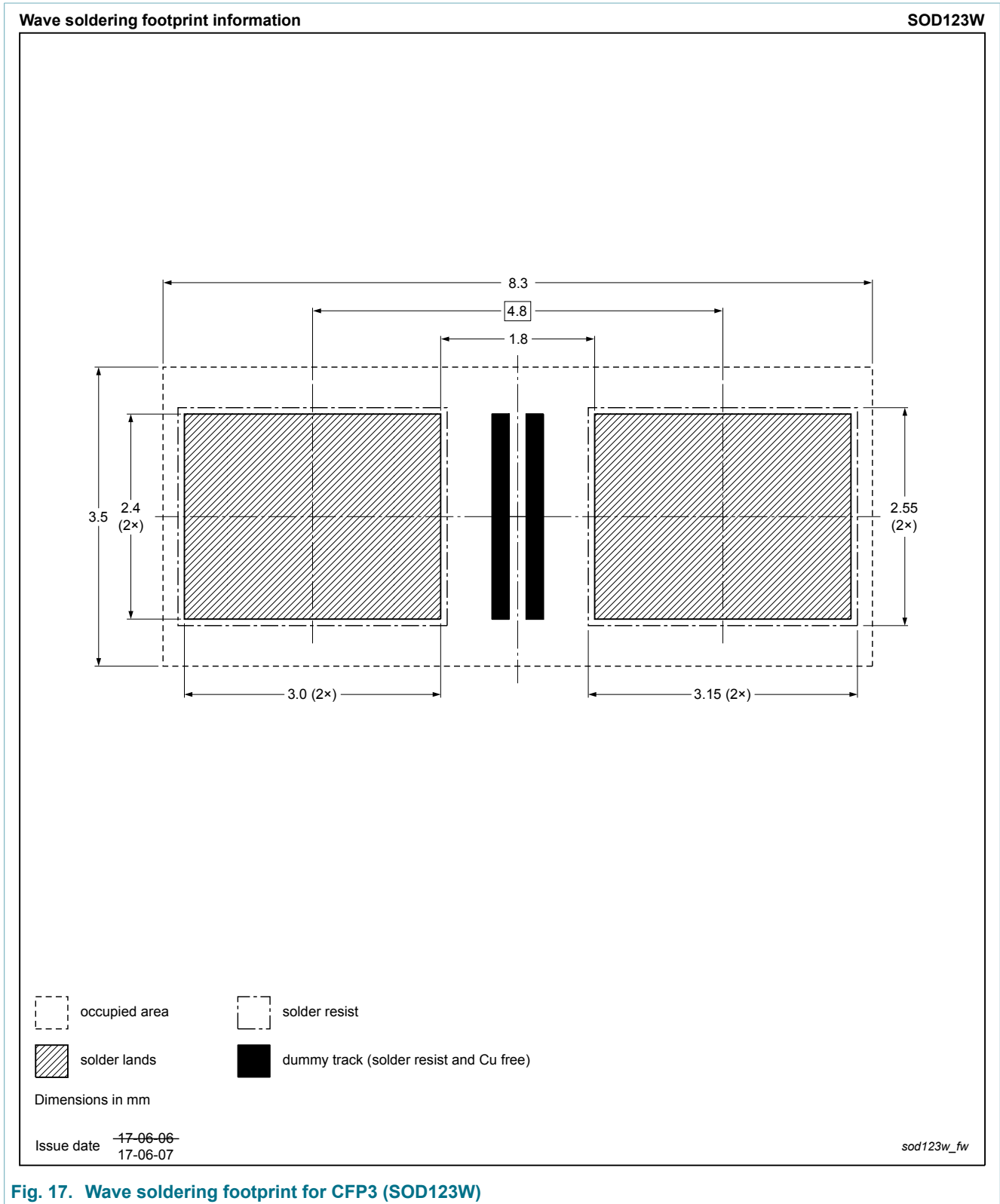


Fig. 16. Reflow soldering footprint for CFP3 (SOD123W)



**Fig. 17. Wave soldering footprint for CFP3 (SOD123W)**

## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
ES1DR v.2	20180328	Product data sheet	-	ES1DR v.1
Modifications:	<ul style="list-style-type: none"><li>• Features and benefits: Capable for reflow and wave soldering added</li><li>• Soldering: Wave soldering footprint added</li></ul>			
ES1DR v.1	20170331	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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Date of release: 28 March 2018

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